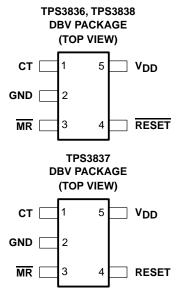
- Supply Current of 220 nA (Typ)
- Precision Supply Voltage Supervision Range: 1.8 V, 2.5 V, 3.0 V, 3.3 V
- Power-On Reset Generator With Selectable Delay Time of 10 ms or 200 ms
- Push/Pull RESET Output (TPS3836), RESET Output (TPS3837), or Open-Drain RESET Output (TPS3838)
- Manual Reset
- 5-Pin SOT-23 Package
- Temperature Range −40°C to 85°C

## description

The TPS3836, TPS3837, TPS3838 families of supervisory circuits provide circuit initialization and timing supervision, primarily for DSP and processor-based systems.

During power on,  $\overline{\text{RESET}}$  is asserted when the supply voltage  $V_{DD}$  becomes higher than 1.1 V. Thereafter, the supervisory circuit monitors  $V_{DD}$  and keeps  $\overline{\text{RESET}}$  output active as long as  $V_{DD}$  remains below the threshold voltage  $V_{IT}$ . An internal timer delays the return of the output to the inactive state (high) to ensure proper system reset. The delay time starts after  $V_{DD}$  has risen above the threshold voltage  $V_{IT}$ .

- Applications Include
  - Applications Using Low-Power DSPs, Microcontrollers, or Microprocessors
  - Portable/Battery-Powered Equipment
  - Intelligent Instruments
  - Wireless Communication Systems
  - Notebook Computers
  - Automotive Systems

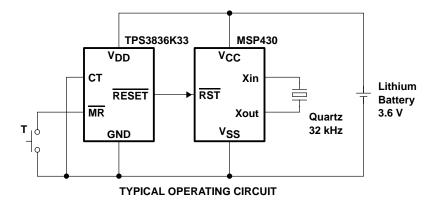


When CT is connected to GND a fixed delay time of typical 10 ms is asserted. When connected to  $V_{DD}$  the delay time is typically 200 ms.

When the supply voltage drops below the threshold voltage V<sub>IT</sub>, the output becomes active (low) again.

All the devices of this family have a fixed-sense threshold voltage V<sub>IT</sub> set by an internal voltage divider.

The TPS3836 has an active-low push-pull RESET output. The TPS3837 has active-high push-pull RESET, and TPS3838 integrates an active-low open-drain RESET output.





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## description (continued)

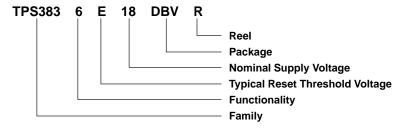
The product spectrum is designed for supply voltages of 1.8 V, 2.5 V, 3 V, and 3.3 V. The circuits are available in a 5-pin SOT-23 package. The TPS3836, TPS3837, TPS3838 families are characterized for operation over a temperature range of  $-40^{\circ}$ C to  $85^{\circ}$ C.

## PACKAGE INFORMATION

TA	DEVICE	NAME	THRESHOLD VOLTAGE	SYMBOL
	TPS3836E18DBVR <sup>†</sup>	TPS3836E18DBVT <sup>‡</sup>	1.71 V	PDNI
	TPS3836J25DBVR <sup>†</sup>	TPS3836J25DBVT <sup>‡</sup>	2.25 V	PDSI
	TPS3836H30DBVR <sup>†</sup>	TPS3836H30DBVT <sup>‡</sup>	2.79 V	PHRI
	TPS3836L30DBVR†	TPS3836L30DBVT‡	2.64 V	PCAI
	TPS3836K33DBVR <sup>†</sup>	TPS3836K33DBVT‡	2.93 V	PDTI
	TPS3837E18DBVR <sup>†</sup>	TPS3837E18DBVT <sup>‡</sup>	1.71 V	PDOI
-40°C to 85°C	TPS3837J25DBVR <sup>†</sup>	TPS3837J25DBVT <sup>‡</sup>	2.25 V	PDRI
	TPS3837L30DBVR†	TPS3837L30DBVT <sup>‡</sup>	2.64 V	PCBI
	TPS3837K33DBVR <sup>†</sup>	TPS3837K33DBVT <sup>‡</sup>	2.93 V	PDUI
	TPS3838E18DBVR <sup>†</sup>	TPS3838E18DBVT <sup>‡</sup>	1.71 V	PDQI
	TPS3838J25DBVR†	TPS3838J25DBVT‡	2.25 V	PDPI
	TPS3838L30DBVR†	TPS3838L30DBVT‡	2.64 V	PCCI
	TPS3838K33DBVR <sup>†</sup>	TPS3838K33DBVT <sup>‡</sup>	2.93 V	PDVI

<sup>†</sup> The DBVR passive indicates tape and reel of 3000 parts.

#### **ORDERING INFORMATION**



## **FUNCTION TABLE TPS3836, TPS3837, TPS3838**

MR	$V_{DD} > V_{IT}$	RESET§	RESET¶
L	0	L	Н
L	1	L	Н
Н	0	L	Н
Н	1	Н	L

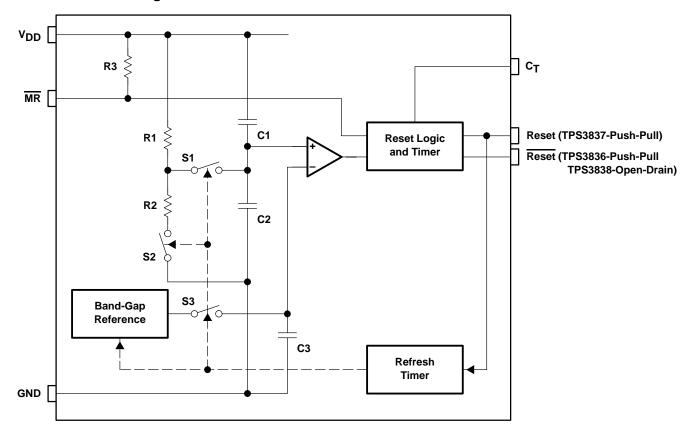
<sup>§</sup> TPS3836 and TPS3838



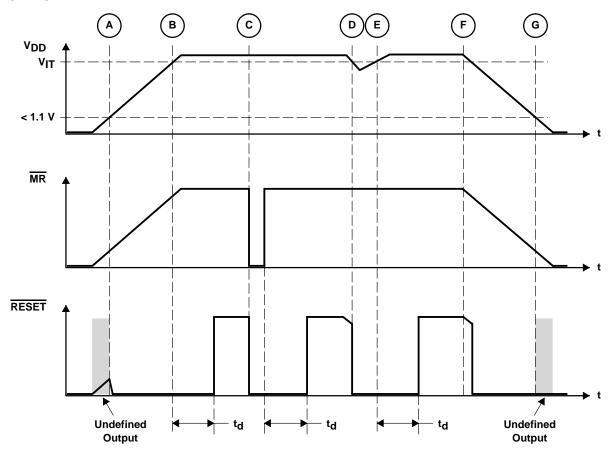
<sup>&</sup>lt;sup>‡</sup> The DBVT passive indicates tape and reel of 250 parts.

<sup>¶</sup>TPS3837

## functional block diagram



## timing diagram





## TPS3836E18 / J25 / H30 / L30 / K33 TPS3837E18 / J25 / L30 / K33, TPS3838E18 / J25 / L30 / K33 NANOPOWER SUPERVISORY CIRCUITS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>DD</sub> (see Note 1)	
All other pins (see Note 1)	
Maximum low output current, IOL	5 mA
Maximum high output current, IOH	–5 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>DD</sub> )	±10 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{DD}$ )	±10 mA
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T <sub>A</sub>	–40°C to 85°C
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C
Soldering temperature	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND. For reliable operation, the device must not be operated at 7 V for more than t=1000 h continuously

#### **DISSIPATION RATING TABLE**

PACKAGE	T <sub>A</sub> <25°C	DERATING FACTOR	T <sub>A</sub> = 70°C	T <sub>A</sub> = 85°C
	POWER RATING	ABOVE T <sub>A</sub> = 25°C	POWER RATING	POWER RATING
DBV	437 mW	3.5 mW/°C	280 mW	227 mW

## recommended operating conditions at specified temperature range

	MIN	MAX	UNIT
Supply voltage, V <sub>DD</sub>	1.6	6	V
Input voltage, V <sub>I</sub>	0	V <sub>DD</sub> + 0.3	V
High-level input voltage, VIH	$0.7 \times V_{DD}$		V
Low-level input voltage, V <sub>IL</sub>		$0.3 \times V_{DD}$	V
Input transition rise and fall rate at $\overline{MR}$ , $\Delta t/\Delta V$		100	ns/V
Operating free-air temperature range, T <sub>A</sub>	-40	85	°C



## TPS3836E18 / J25 / H30 / L30 / K33 TPS3837E18 / J25 / L30 / K33, TPS3838E18 / J25 / L30 / K33 NANOPOWER SUPERVISORY CIRCUITS

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## electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER			TEST CONDITION		MIN	TYP	MAX	UNIT
		RESET	$V_{DD} = 3.3 \text{ V},$	$I_{OH} = -2 \text{ mA}$				
V	Liber level entent velte ee	(TPS3836)	$V_{DD} = 6 V$ ,	$I_{OH} = -3 \text{ mA}$	0.8×			V
VOH	High-level output voltage	RESET	$V_{DD} = 1.8 V$ ,	$I_{OH} = -1 \text{ mA}$	$V_{DD}$			V
		(TPS3837)	$V_{DD} = 3.3 \text{ V},$	$I_{OL} = -2 \text{ mA}$				
		RESET	$V_{DD} = 1.8 V$ ,	$I_{OL} = 1 \text{ mA}$				V
V	Low lovel output voltage	(TPS3836/8)	$V_{DD} = 3.3 V$ ,	$I_{OL} = 2 \text{ mA}$			0.4	
VOL	Low-level output voltage	RESET	$V_{DD} = 3.3 V$ ,	$I_{OL} = 2 \text{ mA}$			0.4	V
		(TPS3837)	$V_{DD} = 6 V$ ,	$I_{OL} = 3 \text{ mA}$				
	Davis vin saast valta sa	TPS3836/8	$V_{DD} \ge 1.1 V$ ,	$I_{OL} = 50 \mu A$			0.2	
	Power-up reset voltage (see Note 2)	TPS3837	V <sub>DD</sub> ≥ 1.1 V,	$I_{OH} = -50  \mu A$	0.8 × V <sub>DD</sub>			V
		TPS383xE18			1.66	1.71	1.74	
		TPS383xJ25			2.18	2.25	2.29	
VIT	Negative-going input threshold voltage (see Note 3)	TPS383xH30	$T_A = -40^{\circ}C \text{ to } 85^{\circ}C$	2.70	2.79	2.85	V	
VO		TPS383xL30		2.56	2.64	2.69		
		TPS383xK33		2.84	2.93	2.99		
			1.7 V < V <sub>IT</sub> < 2.5 V			30		
V <sub>hys</sub>	Hysteresis at V <sub>DD</sub> input		2.5 V < V <sub>IT</sub> < 3.5 V			40		mV
			3.5 V < V <sub>IT</sub> < 5 V			50		
Iн	High-level input current	MR (see Note 4)	$\overline{\text{MR}} = 0.7 \times V_{DD}$	V <sub>DD</sub> = 6 V	-40	-60	-100	μΑ
		СТ	$CT = V_{DD} = 6 V$		-25		25	nA
IIL	Low-level input current	MR (see Note 4)	MR = 0 V,	V <sub>DD</sub> = 6 V	-130	-200	-340	μΑ
		СТ	CT = 0 V,	V <sub>DD</sub> = 6 V	-25		25	nA
ІОН	High-level output current	TPS3838	$V_{DD} = V_{IT} + 0.2 V,$	$V_{OH} = V_{DD}$			25	nA
		•		V <sub>DD</sub> < 3 V		220	400	
I <sub>DD</sub>	Supply current		V <sub>DD</sub> > V <sub>IT</sub> ,	V <sub>DD</sub> > 3 V		250	450	nA
			V <sub>DD</sub> < V <sub>IT</sub>			10	15	μΑ
	Internal pullup resistor at MR				30		kΩ	
Cl	Input capacitance at MR, CT		$V_I = 0 V \text{ to } V_{DD}$			5		pF

NOTES: 2. The lowest voltage at which  $\overline{RESET}$  output becomes active.  $t_{f_1} V_{DD} \ge 15 \ \mu s/V$ 

3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1 µF) should be placed near the supply terminal.

4. If manual reset is unused, MR should be connected to V<sub>DD</sub> to minimize current consumption.



# TPS3836E18 / J25 / H30 / L30 / K33 TPS3837E18 / J25 / L30 / K33, TPS3838E18 / J25 / L30 / K33 NANOPOWER SUPERVISORY CIRCUITS SLVS292A – JUNE 2000 – REVISED JANUARY 2002

## timing requirements at R $_L$ = 1 M $\Omega,\,C_L$ = 50 pF, $T_A$ = 25 $^{\circ}C$

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT	
		at V <sub>DD</sub>	$V_{IH} = V_{IT} + 0.2 V,$	$V_{IL} = V_{IT} - 0.2 V$	6			μs
t <sub>W</sub>	Pulse width	at MR	$V_{DD} \ge V_{IT} + 0.2 \text{ V},$ $V_{IH} = 0.7 \times V_{DD}$	$V_{IL} = 0.3 \times V_{DD}$	1			μs

## switching characteristics at R $_L$ = 1 M $\Omega,\,C_L$ = 50 pF, $T_A$ = 25 $^{\circ}C$

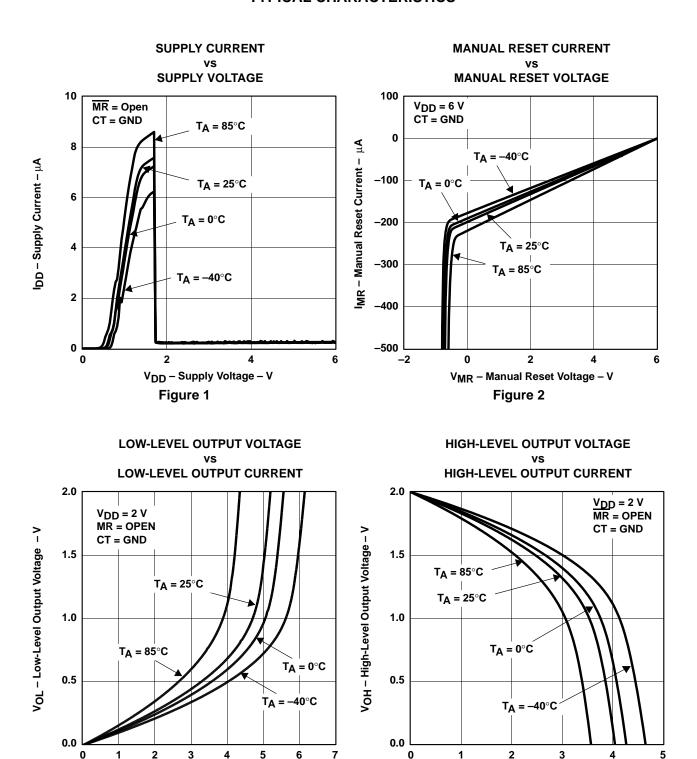
	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
	Polocotico		$\frac{V_{DD}}{MR} \ge V_{IT} + 0.2 \text{ V},$ $MR = 0.7 \times V_{DD},$ $CT = GND,$ See timing diagram	5	10	15	
<sup>t</sup> d	Delay time		$\begin{split} &\frac{V_{DD}}{MR} \geq V_{IT} + 0.2 \text{ V,} \\ &MR = 0.7 \times V_{DD}, \\ &CT = V_{DD} \text{ ,} \\ &\text{See timing diagram} \end{split}$	100	200	300	ms
t <sub>PHL</sub>	Propagation (delay) time, high-to-low-level output	V <sub>DD</sub> to RESET delay	$V_{IL} = V_{IT} - 0.2 V,$ $V_{IH} = V_{IT} + 0.2 V$			10	μs
		(TPS3836, TPS3838)	V <sub>IL</sub> = 1.6 V			50	
tPLH	Propagation (delay) time, low-to-high-level output	V <sub>DD</sub> to RESET delay	$V_{IL} = V_{IT} - 0.2 \text{ V},$ $V_{IH} = V_{IT} + 0.2 \text{ V}$			10	μs
		(TPS3837)	V <sub>IL</sub> = 1.6 V			50	
tPHL	Propagation (delay) time, high-to-low-level output	MR to RESET delay (TPS3836, TPS3838)	$V_{DD} \ge V_{IT} + 0.2 \text{ V},$ $V_{IL} = 0.3 \times V_{DD},$			0.1	μs
tPLH	Propagation (delay) time, low-to-high-level output	MR to RESET delay (TPS3837)	$V_{IL} = 0.7 \times V_{DD}$			0.1	μs

## **TYPICAL CHARACTERISTICS**

## **Table of Graphs**

			FIGURE
IDD	Supply current	vs Supply voltage	1
I <sub>MR</sub>	Manual reset current	vs Manual reset voltage	2
VOL	Low-level output voltage	vs Low-level output current	3
Vон	High-level output voltage	vs High-level output current	4
	Normalized reset threshold voltage	vs Free-air temperature	5
	Minimum pulse duration at V <sub>DD</sub>	vs V <sub>DD</sub> Threshold overdrive	6

#### TYPICAL CHARACTERISTICS





IOL - Low-Level Output Current - mA

Figure 3

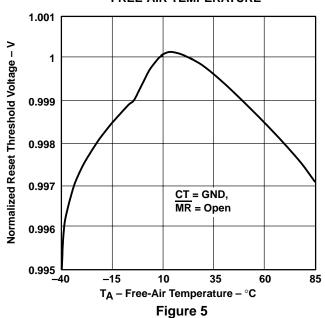
IOH - High-Level Output Current - mA

Figure 4

## **TYPICAL CHARACTERISTICS**

# NORMALIZED RESET THRESHOLD VOLTAGE

## FREE-AIR TEMPERATURE



# MINIMUM PULSE DURATION AT $V_{DD}$

#### vs V<sub>DD</sub> THRESHOLD OVERDRIVE

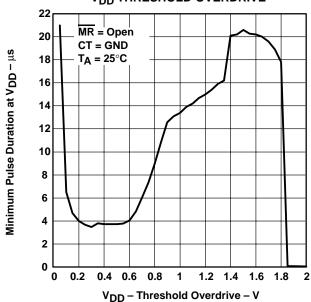


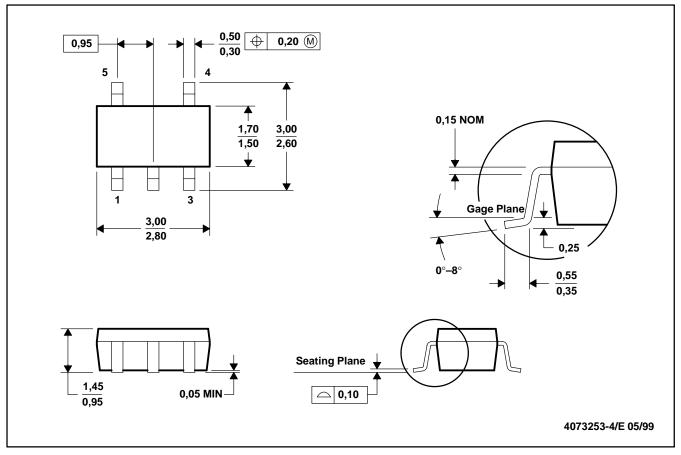
Figure 6



## **MECHANICAL DATA**

## DBV (R-PDSO-G5)

## **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-178



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